# IXYS

# Features:

- µPower Operation (15 µW typical at 25°C)
- Omni polar (switches with N or S pole)
- 2.5 to 5.5 Volt Operation
- Simple Digital Output Interfacing
  Open Drain
- Ultra Low Offset Canceling Amplifiers Provide Sensitive, Accurate, Stable Switching Points and Immunity to Mechanical Stress
- Solid State Circuitry
- Operating Temperature Range: -40°C to +85°C
- RoHS Compliant TSOT-23 3 Lead Package

# **Ordering Information**

U		
Part No.	Description	Qty
MX887DHTTR	TSOT-23 3L Tape & Reel	3000

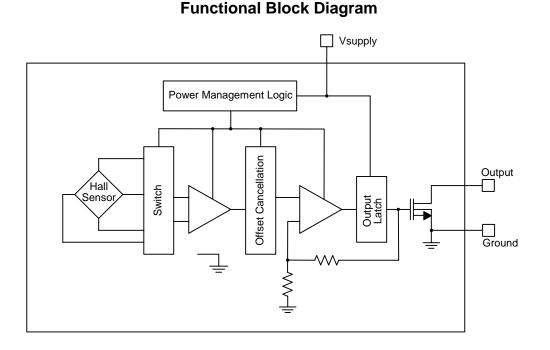
# **General Description**

The MX887D integrated Hall-Effect switch targets the requirements of low-power portable devices with battery operating voltages from 2.5V to 5.5V. Onchip power management circuitry reduces the effective average current to just 5µA at 3.0 VSUPPLY.

The switch output will turn "on" when either a north or south magnetic pole is applied. The absence of a magnetic field will turn the switch into a high impedance "off" state. Emulating the behavior of a traditional reed switch, together with the advantages of high integration and solid state reliability, makes the MX887D is an ideal replacement in low-power portable device applications.

# **Applications:**

- Handheld Portable Devices
- White Goods
- Automotive Body Systems
- Security Systems
- High Reliability Reed Switch Replacement



MX887D Drawing No. 088710

# **Pin Description**

Pin No.	Pin Name	Description
1	VSUPPLY	2.5 to 5.5 Volt
2	OUT	Open Drain N-Channel FET
3	GROUND	Ground

# **Circuit Description**

The MX887D µPower Hall-Effect Switch consists of a Hall element, small signal amplifier, latch, and nchannel open drain MOSFET driver. Offset cancellation rejects errors in signal stages and the influence of mechanical stress on the Hall element. This technique together with a precision threshold generator and comparator produce highly accurate magnetic switch points. The Hall element is activated for a small fraction of an operating cycle, then latched in that sample state for the remainder of the period. By using this technique, very low power consumption is achieved.

# **Electrical Characteristics**

Over operating voltage and temperature range unless otherwise noted.

Parameter	Condition	Min	Тур	Max	Unit
Supply Voltage		2.5		5.5	V
Output Leakage Current	VOUT = 5.5V, BRPN < B < BRPS		<1.0	1.0	μA
Output On Voltage	IOUT = 1mA, VDD = 3.0V		100	300	mV
Awake Time				90	μS
Period				90	mS
Duty Cycle			0.1		%
Supply Current	Awake (enabled)			2.0	mA
	Asleep (disabled)			8.0	μA
	Average (Calculated)		5	15	μA
ESD	Human Body Model	2			kV

Notes: 1. Operating and release points will vary with supply voltage.

2. BOPX = operating point (output turns ON); BRPX = release point (output turns OFF).

3. Typical Data is at TA =  $25^{\circ}$ C and VSUPPLY = 3.0V.

# Magnetic Characteristics

Over operating voltage and temperature range unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Operating Points	BOPS	South pole to branded side			60	G
	BOPN	North pole to branded side	-60			G
Release Points	Brps	South pole to branded side	6			G
	Brpn	North pole to branded side			-6	G
Hysteresis	Bhys	Bopx – Brpx		5		G

Notes: 1. As use here, negative flux densities are defined as less than zero (algebraic convention) and -50G is less than +10G.

2. BOPX = operating point (output turns ON); BRPX = release point (output turns OFF).

3. Typical Data is at TA =  $25^{\circ}$ C and VSUPPLY = 3.0V.

# **MX887D**



DIMENSIONS TSOT23 - 3 LEAD INCH MILLIMETER DIM. MIN NDM. MAX. MIN, NDM. MAX. D А 0.030 \_ 0.035 0.75 \_ 0.90 ł Ξ Α1 0.000 \_ 0.004 0.00 \_ 0.10 ш ıĻ гЦ Α2 0.028 0.030 0.031 0.70 0.75 0.80 С e 0.014 \_ 0.020 0.35 0.51 b \_ L2 e1 0.004 \_ 0.010 \_ 0.25 PLANE  $\subset$ 0.10 D 0.110 0.114 0.118 2.80 2.90 3.00 GAUGE Е 0.102 0.110 0.118 2.60 2.80 3.00 E1 0.059 0.063 0.067 1.50 1.60 1.70 A1 A1 0.0374 BSC 0.95 BSC е e1 0.0748 BSC 1.90 BSC PACKAGE TOP MAY BE SMALLER THAN PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE DUTERMOST EXTREME OF THE PLASTIC BODY EXCLUDING MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN TOP AND BOTTOM OF THE PLASTIC BODY. З, 0.015 0.37 L L10.0236 REF 0.60 REF L2 0.0098 BSC 0.25 BSC DIMENSION "E" DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSION SHALL NOT EXCEED .006" (0.15MM) PER SIDE. 0.004 0.10 У \_ \_ \_ \_ 2. R 0.004 \_ 0.10 \_ DIMENSION 'D' DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED .004 IN. (0.10MM) PER SIDE. 0° 0° 8° К 8° 1. \_ К1 7° N⊡M 7° NDM К2 5° NDM 5° NOM NOTES: (UNLESS OTHERWISE SPECIFIED)

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MX887D Drawing No. 088710